

## Trench gate field-stop IGBT M series, 650 V, 15 A low-loss

Datasheet - production data

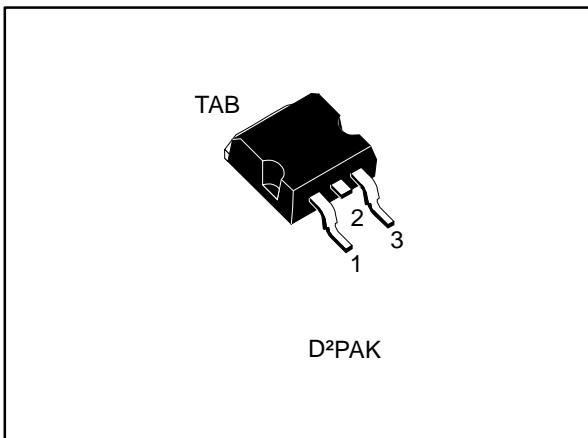
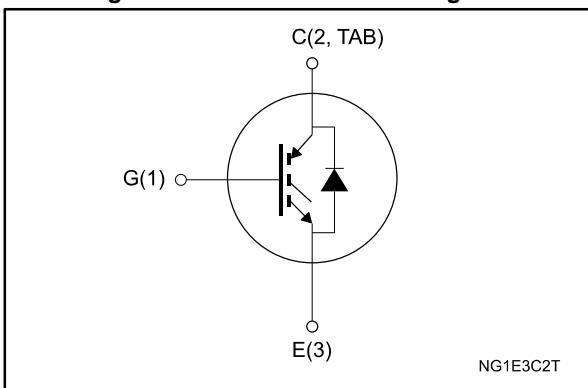


Figure 1: Internal schematic diagram



### Features

- 6  $\mu$ s of short-circuit withstand time
- $V_{CE(sat)} = 1.55$  V (typ.) @  $I_c = 15$  A
- Tight parameter distribution
- Safer paralleling
- Low thermal resistance
- Soft and very fast recovery antiparallel diode

### Applications

- Motor control
- UPS
- PFC

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the M series IGBTs, which represent an optimal balance between inverter system performance and efficiency where low-loss and short-circuit functionality are essential. Furthermore, the positive  $V_{CE(sat)}$  temperature coefficient and tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

| Order code   | Marking   | Package | Packing       |
|--------------|-----------|---------|---------------|
| STGB15M65DF2 | G15M65DF2 | D²PAK   | Tape and reel |

**Contents**

|          |                                                              |           |
|----------|--------------------------------------------------------------|-----------|
| <b>1</b> | <b>Electrical ratings .....</b>                              | <b>3</b>  |
| <b>2</b> | <b>Electrical characteristics .....</b>                      | <b>4</b>  |
| 2.1      | Electrical characteristics (curves) .....                    | 7         |
| <b>3</b> | <b>Test circuits .....</b>                                   | <b>13</b> |
| <b>4</b> | <b>Package information .....</b>                             | <b>14</b> |
| 4.1      | D <sup>2</sup> PAK (TO-263) type A package information ..... | 14        |
| 4.2      | D <sup>2</sup> PAK packing information .....                 | 17        |
| <b>5</b> | <b>Revision history .....</b>                                | <b>19</b> |

# 1 Electrical ratings

**Table 2: Absolute maximum ratings**

| <b>Symbol</b>  | <b>Parameter</b>                               | <b>Value</b> | <b>Unit</b> |
|----------------|------------------------------------------------|--------------|-------------|
| $V_{CES}$      | Collector-emitter voltage ( $V_{GE} = 0$ V)    | 650          | V           |
| $I_C$          | Continuous collector current at $T_C = 25$ °C  | 30           | A           |
|                | Continuous collector current at $T_C = 100$ °C | 15           |             |
| $I_{CP}^{(1)}$ | Pulsed collector current                       | 60           | A           |
| $V_{GE}$       | Gate-emitter voltage                           | $\pm 20$     | V           |
| $I_F$          | Continuous forward current at $T_C = 25$ °C    | 30           | A           |
|                | Continuous forward current at $T_C = 100$ °C   | 15           |             |
| $I_{FP}^{(1)}$ | Pulsed forward current                         | 60           | A           |
| $P_{TOT}$      | Total dissipation at $T_C = 25$ °C             | 136          | W           |
| $T_{STG}$      | Storage temperature range                      | - 55 to 150  | °C          |
| $T_J$          | Operating junction temperature range           | - 55 to 175  | °C          |

**Notes:**

(1)Pulse width limited by maximum junction temperature.

**Table 3: Thermal data**

| <b>Symbol</b> | <b>Parameter</b>                       | <b>Value</b> | <b>Unit</b> |
|---------------|----------------------------------------|--------------|-------------|
| $R_{thJC}$    | Thermal resistance junction-case IGBT  | 1.1          | °C/W        |
| $R_{thJC}$    | Thermal resistance junction-case diode | 2.08         |             |
| $R_{thJA}$    | Thermal resistance junction-ambient    | 62.5         |             |

## 2 Electrical characteristics

$T_C = 25^\circ\text{C}$  unless otherwise specified

Table 4: Static characteristics

| Symbol               | Parameter                            | Test conditions                                                      | Min. | Typ. | Max.      | Unit          |
|----------------------|--------------------------------------|----------------------------------------------------------------------|------|------|-----------|---------------|
| $V_{(BR)CES}$        | Collector-emitter breakdown voltage  | $V_{GE} = 0 \text{ V}, I_C = 2 \text{ mA}$                           | 650  |      |           | V             |
| $V_{CE(\text{sat})}$ | Collector-emitter saturation voltage | $V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}$                          |      | 1.55 | 2.0       | V             |
|                      |                                      | $V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}, T_J = 125^\circ\text{C}$ |      | 1.9  |           |               |
|                      |                                      | $V_{GE} = 15 \text{ V}, I_C = 15 \text{ A}, T_J = 175^\circ\text{C}$ |      | 2.1  |           |               |
| $V_F$                | Forward on-voltage                   | $I_F = 15 \text{ A}$                                                 |      | 1.7  |           | V             |
|                      |                                      | $I_F = 15 \text{ A}, T_J = 125^\circ\text{C}$                        |      | 1.5  |           |               |
|                      |                                      | $I_F = 15 \text{ A}, T_J = 175^\circ\text{C}$                        |      | 1.4  |           |               |
| $V_{GE(\text{th})}$  | Gate threshold voltage               | $V_{CE} = V_{GE}, I_C = 500 \mu\text{A}$                             | 5    | 6    | 7         | V             |
| $I_{CES}$            | Collector cut-off current            | $V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$                       |      |      | 25        | $\mu\text{A}$ |
| $I_{GES}$            | Gate-emitter leakage current         | $V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$                    |      |      | $\pm 250$ | $\mu\text{A}$ |

Table 5: Dynamic characteristics

| Symbol    | Parameter                    | Test conditions                                                                                                                     | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $C_{ies}$ | Input capacitance            | $V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GE} = 0 \text{ V}$                                                                    | -    | 1250 | -    | pF   |
| $C_{oes}$ | Output capacitance           |                                                                                                                                     | -    | 80   | -    |      |
| $C_{res}$ | Reverse transfer capacitance |                                                                                                                                     | -    | 25   | -    |      |
| $Q_g$     | Total gate charge            | $V_{CC} = 520 \text{ V}, I_C = 15 \text{ A}, V_{GE} = 15 \text{ V}$<br>(see <a href="#">Figure 30: "Gate charge test circuit"</a> ) | -    | 45   | -    | nC   |
| $Q_{ge}$  | Gate-emitter charge          |                                                                                                                                     | -    | 11   | -    |      |
| $Q_{gc}$  | Gate-collector charge        |                                                                                                                                     | -    | 15   | -    |      |

Table 6: IGBT switching characteristics (inductive load)

| Symbol          | Parameter                    | Test conditions                                                                                                                                                                                      | Min. | Typ. | Max. | Unit             |
|-----------------|------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------------------|
| $t_{d(on)}$     | Turn-on delay time           | $V_{CE} = 400 \text{ V}, I_C = 15 \text{ A}, V_{GE} = 15 \text{ V}, R_G = 12 \Omega$ (see <a href="#">Figure 29: "Test circuit for inductive load switching"</a> )                                   |      | 24   | -    | ns               |
| $t_r$           | Current rise time            |                                                                                                                                                                                                      |      | 7.8  | -    | ns               |
| $(di/dt)_{on}$  | Turn-on current slope        |                                                                                                                                                                                                      |      | 1570 | -    | A/ $\mu\text{s}$ |
| $t_{d(off)}$    | Turn-off-delay time          |                                                                                                                                                                                                      |      | 93   | -    | ns               |
| $t_f$           | Current fall time            |                                                                                                                                                                                                      |      | 106  | -    | ns               |
| $E_{on}^{(1)}$  | Turn-on switching energy     |                                                                                                                                                                                                      |      | 0.09 | -    | mJ               |
| $E_{off}^{(2)}$ | Turn-off switching energy    |                                                                                                                                                                                                      |      | 0.45 | -    | mJ               |
| $E_{ts}$        | Total switching energy       |                                                                                                                                                                                                      |      | 0.54 | -    | mJ               |
| $t_{d(on)}$     | Turn-on delay time           | $V_{CE} = 400 \text{ V}, I_C = 15 \text{ A}, V_{GE} = 15 \text{ V}, R_G = 12 \Omega, T_J = 175 \text{ }^\circ\text{C}$ (see <a href="#">Figure 29: "Test circuit for inductive load switching"</a> ) |      | 24.8 | -    | ns               |
| $t_r$           | Current rise time            |                                                                                                                                                                                                      |      | 9.2  | -    | ns               |
| $(di/dt)_{on}$  | Turn-on current slope        |                                                                                                                                                                                                      |      | 1300 | -    | A/ $\mu\text{s}$ |
| $t_{d(off)}$    | Turn-off-delay time          |                                                                                                                                                                                                      |      | 96   | -    | ns               |
| $t_f$           | Current fall time            |                                                                                                                                                                                                      |      | 169  | -    | ns               |
| $E_{on}$        | Turn-on switching energy     |                                                                                                                                                                                                      |      | 0.22 | -    | mJ               |
| $E_{off}$       | Turn-off switching energy    |                                                                                                                                                                                                      |      | 0.61 | -    | mJ               |
| $E_{ts}$        | Total switching energy       |                                                                                                                                                                                                      |      | 0.83 | -    | mJ               |
| $t_{sc}$        | Short-circuit withstand time | $V_{CC} \leq 400 \text{ V}, V_{GE} = 15 \text{ V}, T_{Jstart} = 150 \text{ }^\circ\text{C}$                                                                                                          | 6    |      | -    | $\mu\text{s}$    |
|                 |                              | $V_{CC} \leq 400 \text{ V}, V_{GE} = 13 \text{ V}, T_{Jstart} = 150 \text{ }^\circ\text{C}$                                                                                                          | 10   |      |      |                  |

**Notes:**

(1) Including the reverse recovery of the diode.

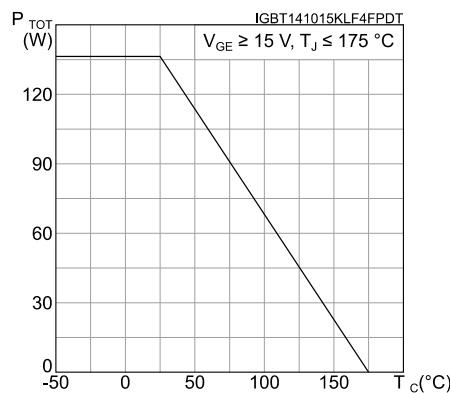
(2) Including the tail of the collector current.

Table 7: Diode switching characteristics (inductive load)

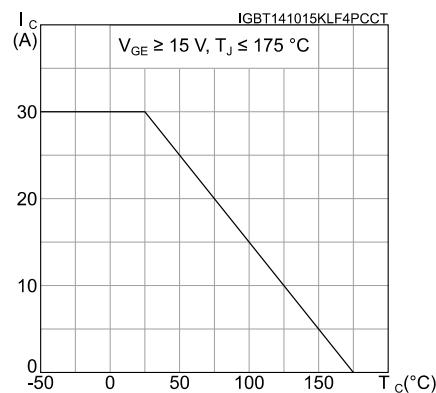
| Symbol       | Parameter                                                  | Test conditions                                                                                                                                                                                                      | Min. | Typ. | Max. | Unit             |
|--------------|------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------------------|
| $t_{rr}$     | Reverse recovery time                                      | $I_F = 15 \text{ A}, V_R = 400 \text{ V}, V_{GE} = 15 \text{ V}$<br>(see <i>Figure 29: "Test circuit for inductive load switching"</i> )<br>$di/dt = 1000 \text{ A}/\mu\text{s}$                                     | -    | 142  | -    | ns               |
| $Q_{rr}$     | Reverse recovery charge                                    |                                                                                                                                                                                                                      | -    | 525  | -    | nC               |
| $I_{rrm}$    | Reverse recovery current                                   |                                                                                                                                                                                                                      | -    | 13.4 | -    | A                |
| $dI_{rr}/dt$ | Peak rate of fall of reverse recovery current during $t_b$ |                                                                                                                                                                                                                      | -    | 790  | -    | A/ $\mu\text{s}$ |
| $E_{rr}$     | Reverse recovery energy                                    |                                                                                                                                                                                                                      | -    | 64   | -    | $\mu\text{J}$    |
| $t_{rr}$     | Reverse recovery time                                      | $I_F = 15 \text{ A}, V_R = 400 \text{ V}, V_{GE} = 15 \text{ V},$<br>$T_J = 175 \text{ }^\circ\text{C}$ (see <i>Figure 29: "Test circuit for inductive load switching"</i> )<br>$di/dt = 1000 \text{ A}/\mu\text{s}$ | -    | 241  | -    | ns               |
| $Q_{rr}$     | Reverse recovery charge                                    |                                                                                                                                                                                                                      | -    | 1690 | -    | nC               |
| $I_{rrm}$    | Reverse recovery current                                   |                                                                                                                                                                                                                      | -    | 20   | -    | A                |
| $dI_{rr}/dt$ | Peak rate of fall of reverse recovery current during $t_b$ |                                                                                                                                                                                                                      | -    | 420  | -    | A/ $\mu\text{s}$ |
| $E_{rr}$     | Reverse recovery energy                                    |                                                                                                                                                                                                                      | -    | 176  | -    | $\mu\text{J}$    |

## 2.1 Electrical characteristics (curves)

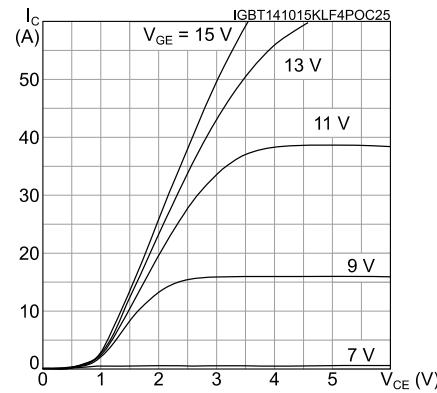
**Figure 2: Power dissipation vs. case temperature**



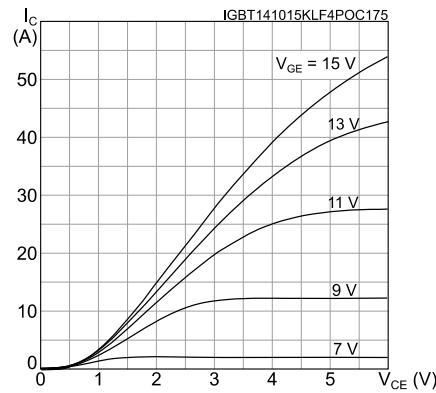
**Figure 3: Collector current vs. case temperature**



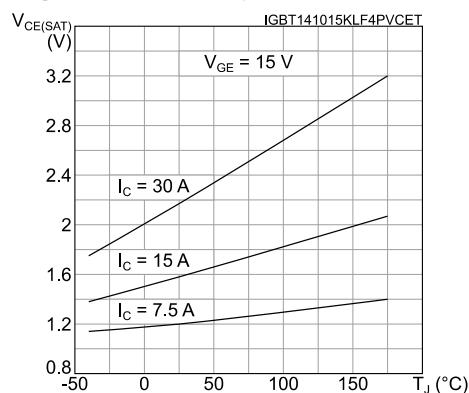
**Figure 4: Output characteristics ( $T_J = 25$  °C)**



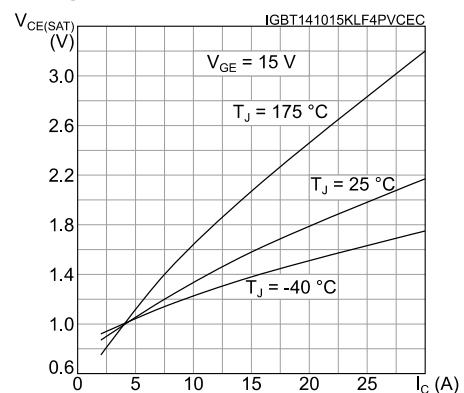
**Figure 5: Output characteristics ( $T_J = 175$  °C)**

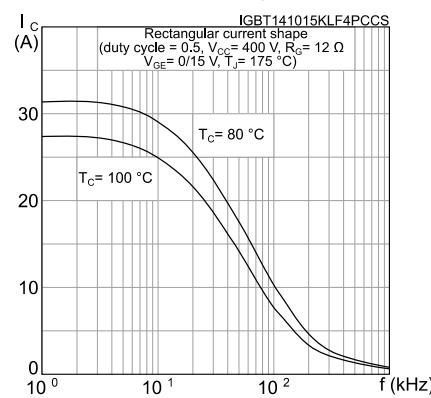
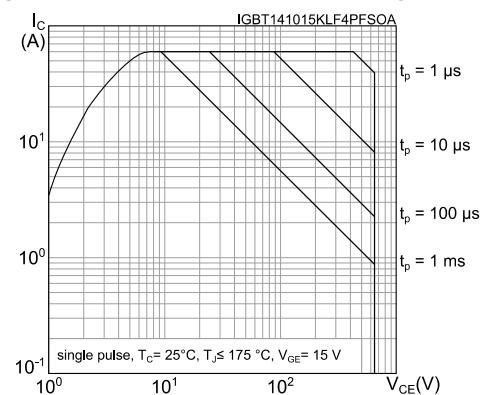
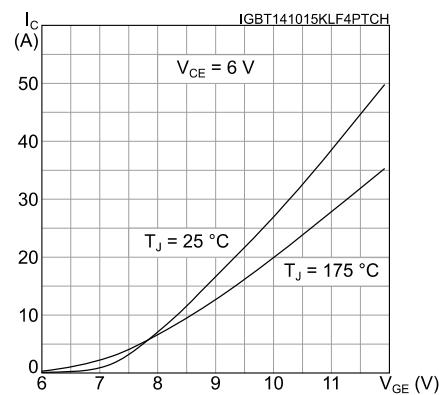
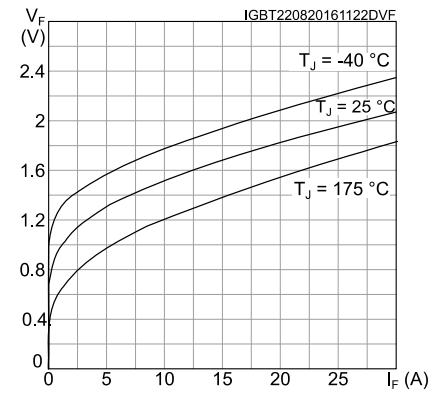
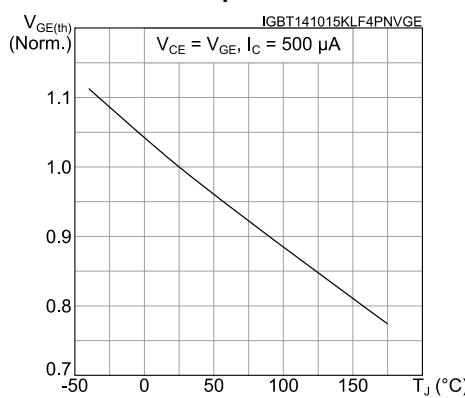
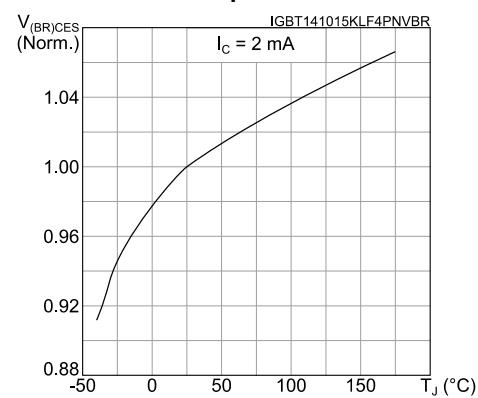


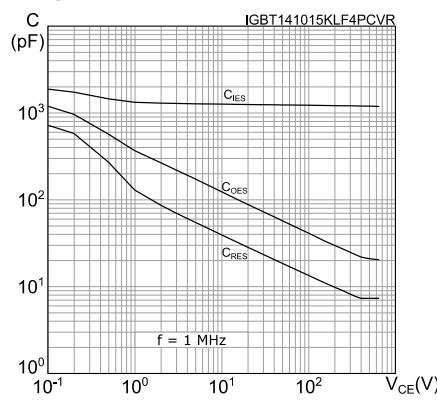
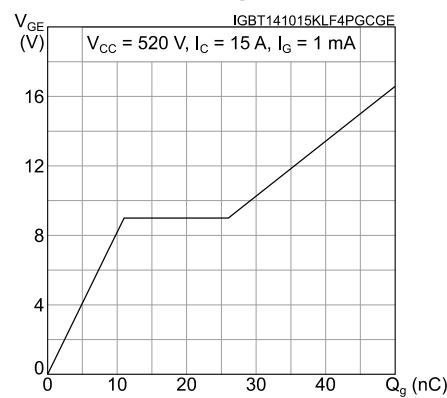
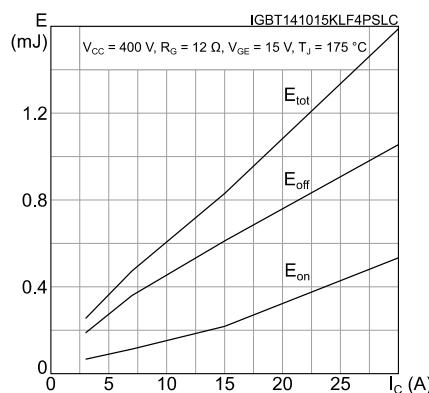
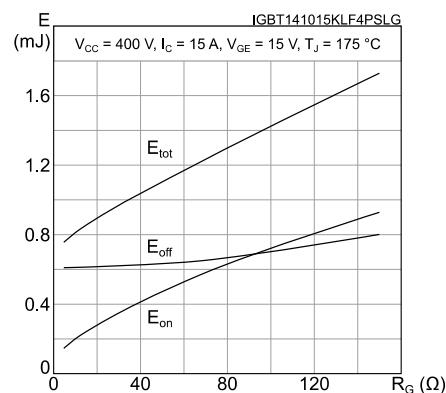
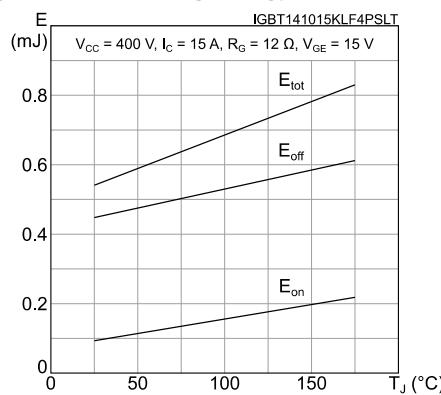
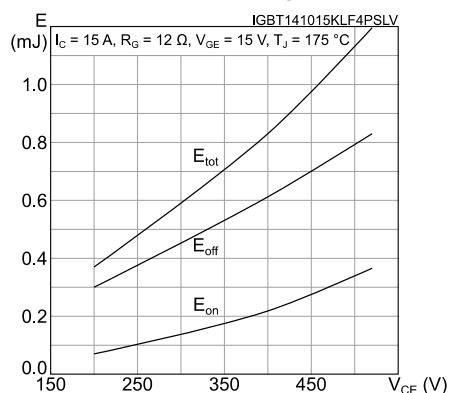
**Figure 6:  $V_{CE(sat)}$  vs. junction temperature**



**Figure 7:  $V_{CE(sat)}$  vs. collector current**



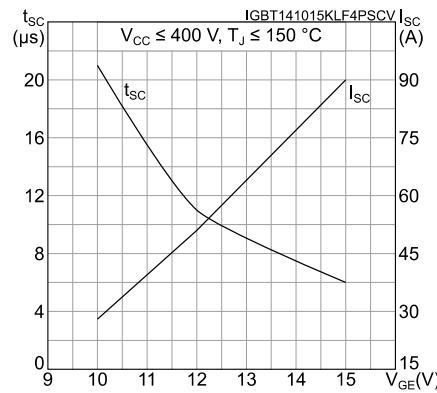
**Figure 8: Collector current vs. switching frequency****Figure 9: Forward bias safe operating area****Figure 10: Transfer characteristics****Figure 11: Diode  $V_F$  vs. forward current****Figure 12: Normalized  $V_{GE(th)}$  vs. junction temperature****Figure 13: Normalized  $V_{(BR)CES}$  vs. junction temperature**

**Figure 14: Capacitance variations****Figure 15: Gate charge vs. gate-emitter voltage****Figure 16: Switching energy vs. collector current****Figure 17: Switching energy vs. gate resistance****Figure 18: Switching energy vs. temperature****Figure 19: Switching energy vs. collector-emitter voltage**

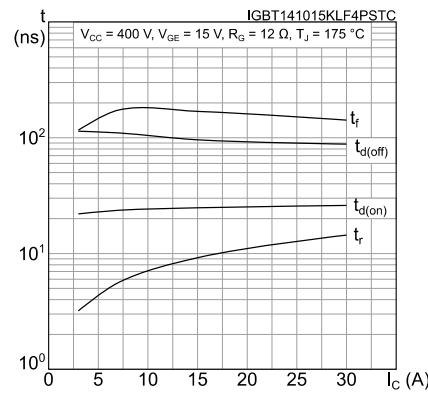
## Electrical characteristics

STGB15M65DF2

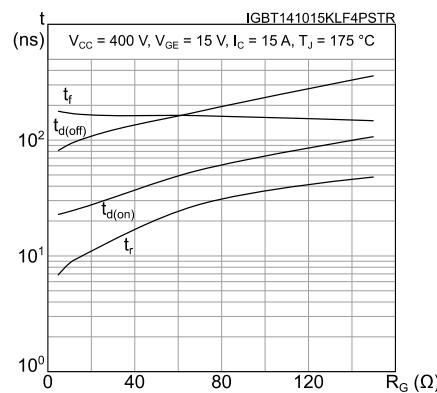
**Figure 20: Short-circuit time and current vs.  $V_{GE}$**



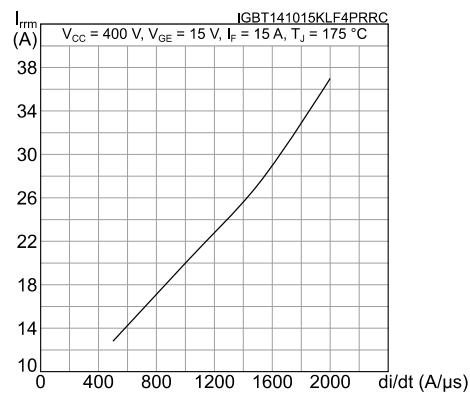
**Figure 21: Switching times vs. collector current**



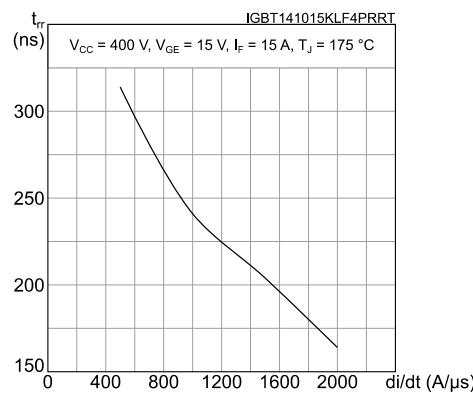
**Figure 22: Switching times vs. gate resistance**



**Figure 23: Reverse recovery current vs. diode current slope**



**Figure 24: Reverse recovery time vs. diode current slope**



**Figure 25: Reverse recovery charge vs. diode current slope**

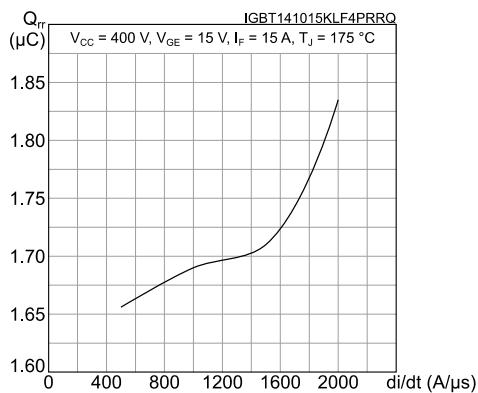


Figure 26: Reverse recovery energy vs. diode current slope

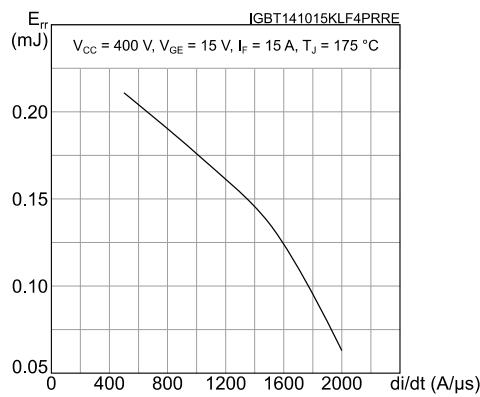


Figure 27: Thermal impedance for IGBT

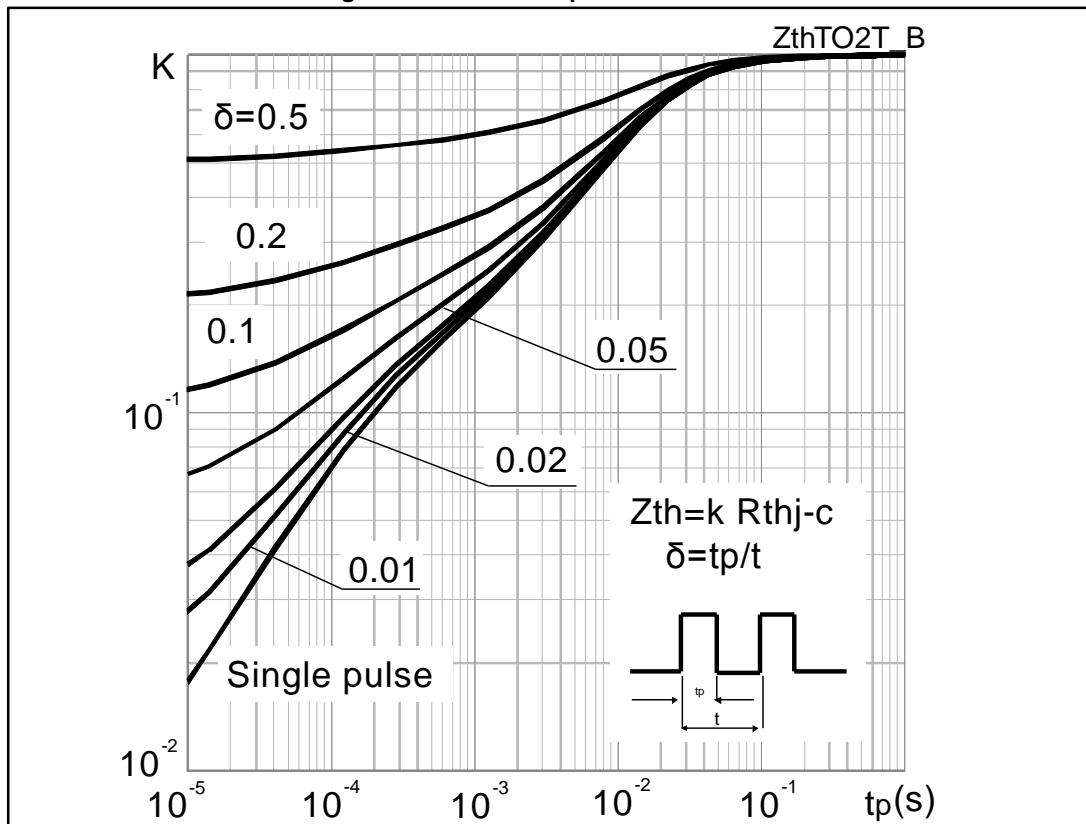
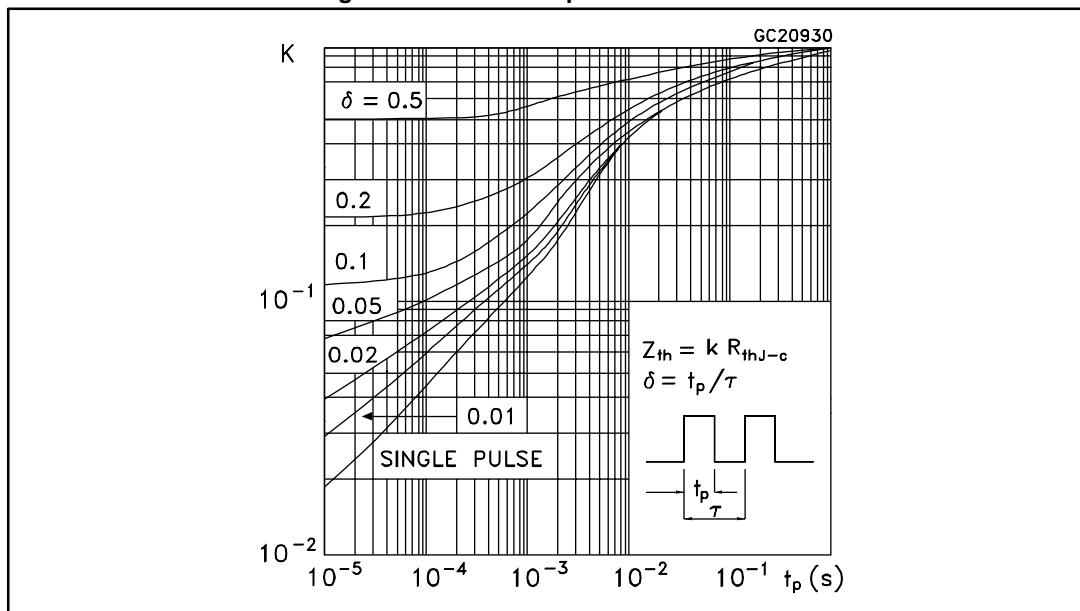
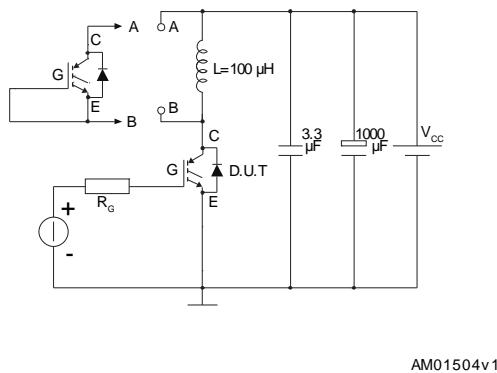


Figure 28: Thermal impedance for diode

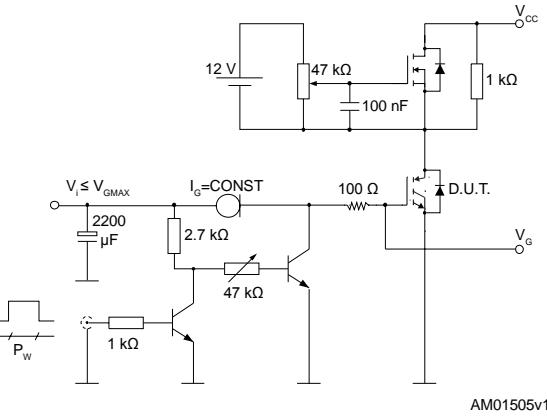


### 3 Test circuits

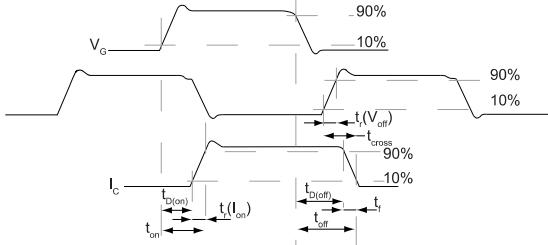
**Figure 29: Test circuit for inductive load switching**



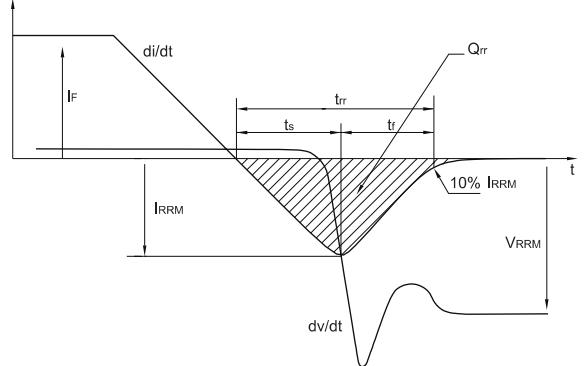
**Figure 30: Gate charge test circuit**



**Figure 31: Switching waveform**



**Figure 32: Diode reverse recovery waveform**



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

### 4.1 D<sup>2</sup>PAK (TO-263) type A package information

Figure 33: D<sup>2</sup>PAK (TO-263) type A package outline

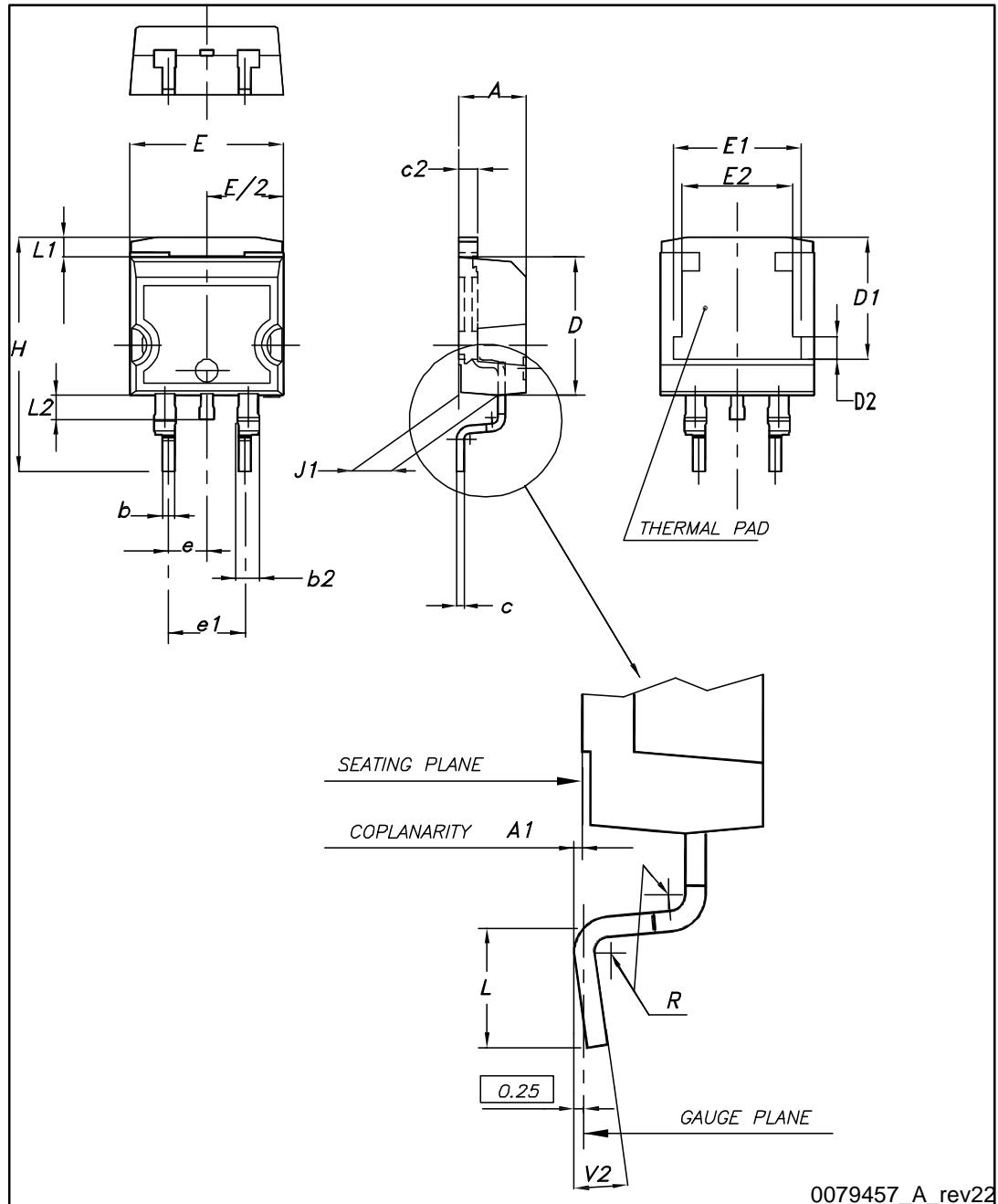
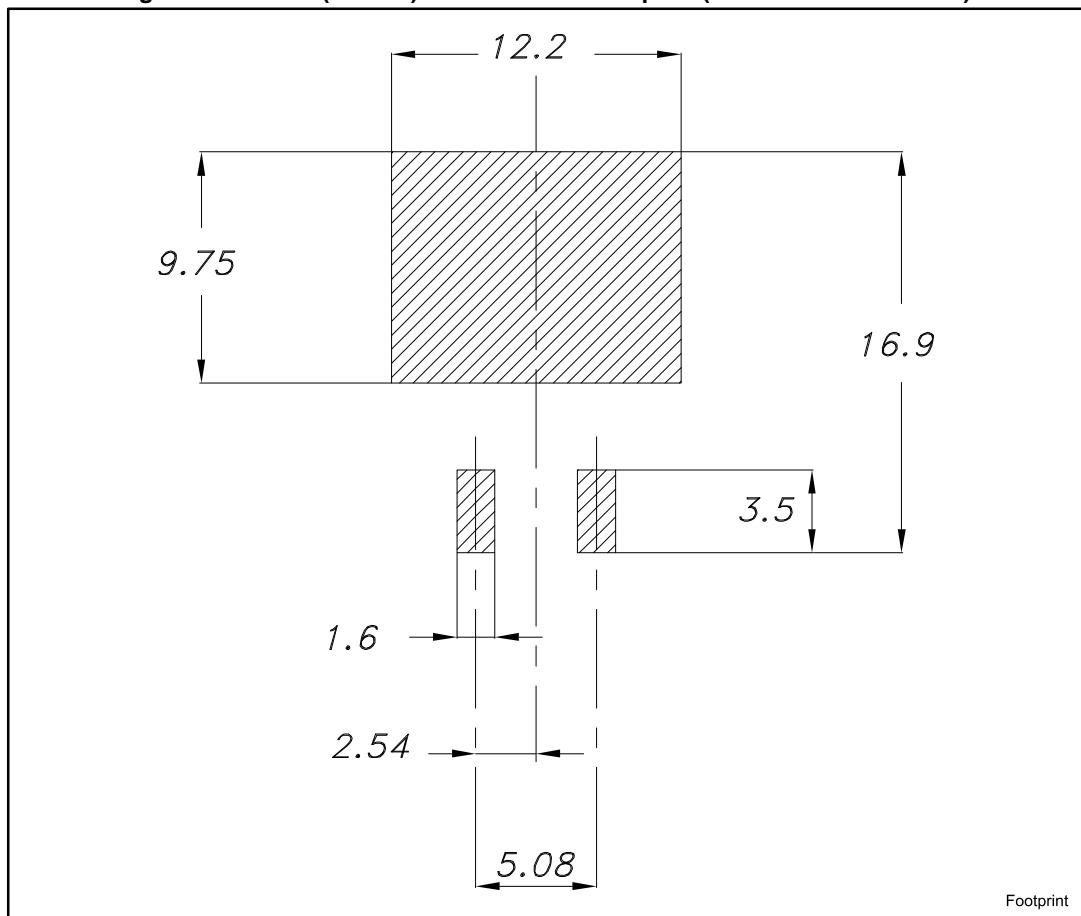


Table 8: D<sup>2</sup>PAK (TO-263) type A package mechanical data

| Dim. | mm   |      |       |
|------|------|------|-------|
|      | Min. | Typ. | Max.  |
| A    | 4.40 |      | 4.60  |
| A1   | 0.03 |      | 0.23  |
| b    | 0.70 |      | 0.93  |
| b2   | 1.14 |      | 1.70  |
| c    | 0.45 |      | 0.60  |
| c2   | 1.23 |      | 1.36  |
| D    | 8.95 |      | 9.35  |
| D1   | 7.50 | 7.75 | 8.00  |
| D2   | 1.10 | 1.30 | 1.50  |
| E    | 10   |      | 10.40 |
| E1   | 8.50 | 8.70 | 8.90  |
| E2   | 6.85 | 7.05 | 7.25  |
| e    |      | 2.54 |       |
| e1   | 4.88 |      | 5.28  |
| H    | 15   |      | 15.85 |
| J1   | 2.49 |      | 2.69  |
| L    | 2.29 |      | 2.79  |
| L1   | 1.27 |      | 1.40  |
| L2   | 1.30 |      | 1.75  |
| R    |      | 0.4  |       |
| V2   | 0°   |      | 8°    |

Figure 34: D<sup>2</sup>PAK (TO-263) recommended footprint (dimensions are in mm)

## 4.2 D<sup>2</sup>PAK packing information

Figure 35: Tape outline

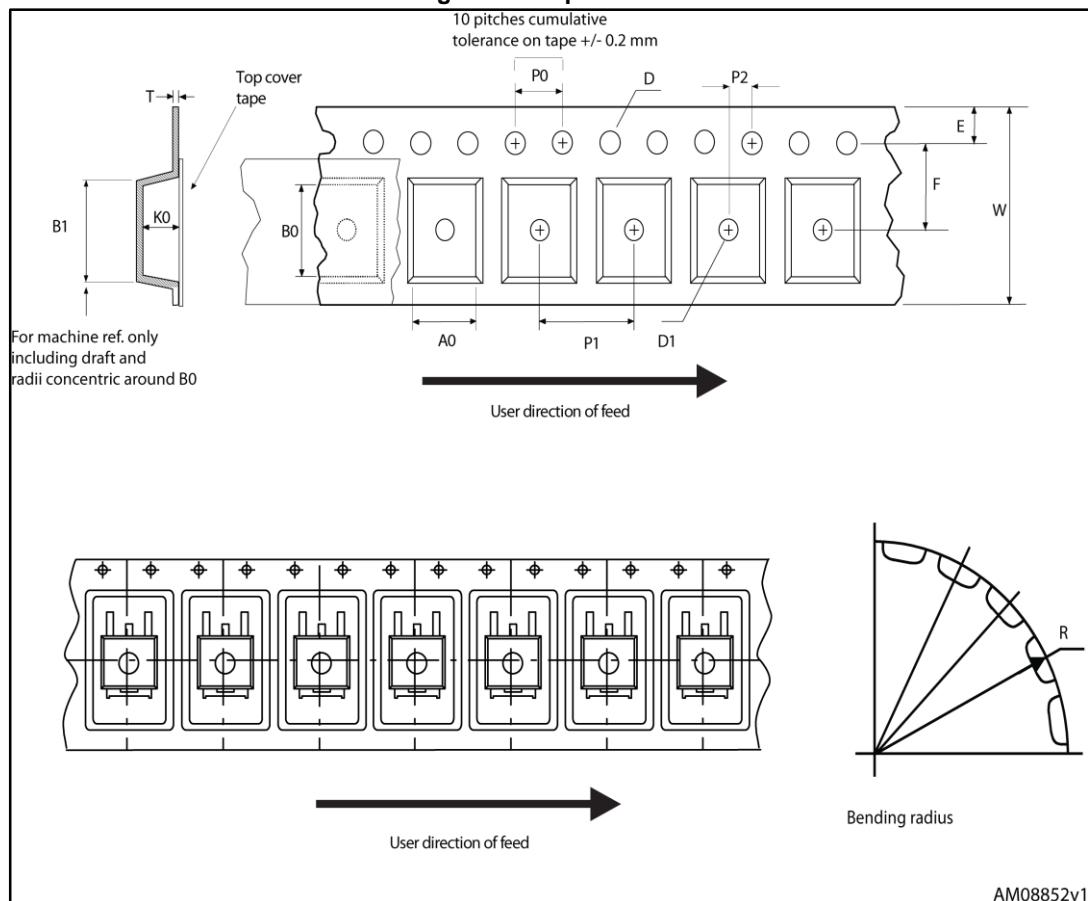
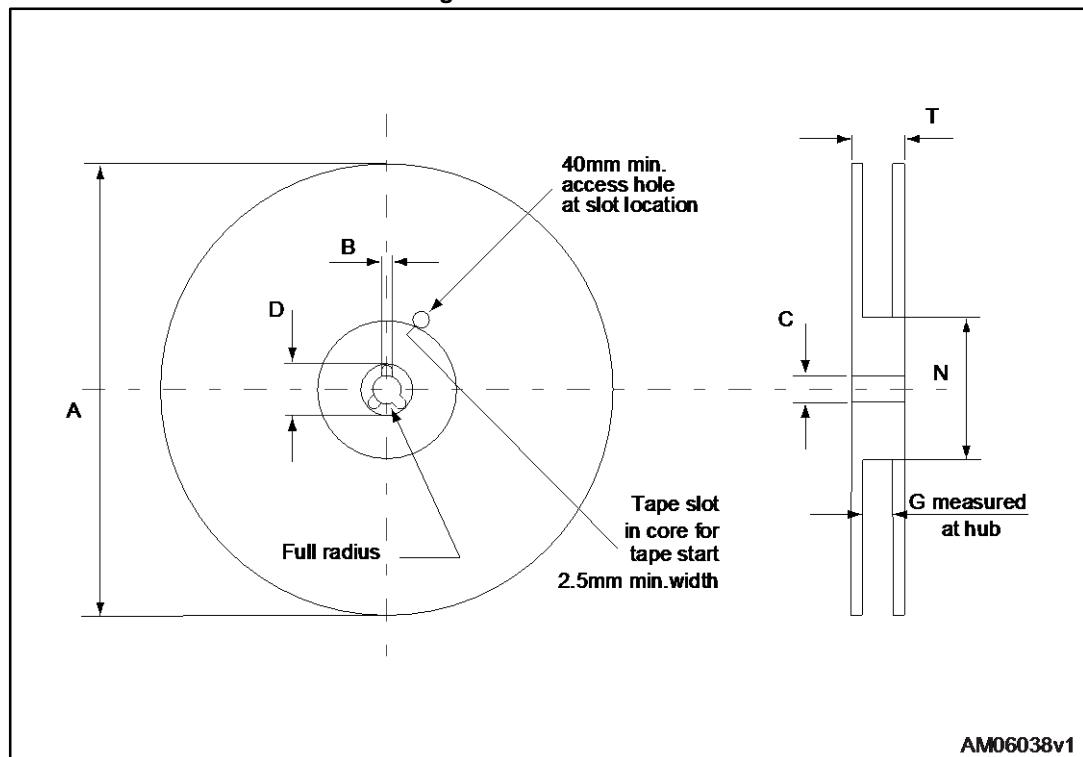


Figure 36: Reel outline

Table 9: D<sup>2</sup>PAK tape and reel mechanical data

| Tape |      |      | Reel          |      |      |
|------|------|------|---------------|------|------|
| Dim. | mm   |      | Dim.          | mm   |      |
|      | Min. | Max. |               | Min. | Max. |
| A0   | 10.5 | 10.7 | A             |      | 330  |
| B0   | 15.7 | 15.9 | B             | 1.5  |      |
| D    | 1.5  | 1.6  | C             | 12.8 | 13.2 |
| D1   | 1.59 | 1.61 | D             | 20.2 |      |
| E    | 1.65 | 1.85 | G             | 24.4 | 26.4 |
| F    | 11.4 | 11.6 | N             | 100  |      |
| K0   | 4.8  | 5.0  | T             |      | 30.4 |
| P0   | 3.9  | 4.1  |               |      |      |
| P1   | 11.9 | 12.1 | Base quantity |      | 1000 |
| P2   | 1.9  | 2.1  | Bulk quantity |      | 1000 |
| R    | 50   |      |               |      |      |
| T    | 0.25 | 0.35 |               |      |      |
| W    | 23.7 | 24.3 |               |      |      |

## 5 Revision history

Table 10: Document revision history

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 14-Oct-2015 | 1        | First release.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 13-Nov-2015 | 2        | Document status promoted from preliminary to production data.                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 22-Aug-2016 | 3        | Updated <a href="#">Table 2: "Absolute maximum ratings"</a> and <a href="#">Table 6: "IGBT switching characteristics (inductive load)"</a> .<br>Updated <a href="#">Figure 16: "Switching energy vs. collector current"</a> , <a href="#">Figure 17: "Switching energy vs. gate resistance"</a> , <a href="#">Figure 18: "Switching energy vs. temperature"</a> and <a href="#">Figure 19: "Switching energy vs. collector emitter voltage"</a> .<br>Changed <a href="#">Figure 11: "Diode VF vs. forward current"</a> . |

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